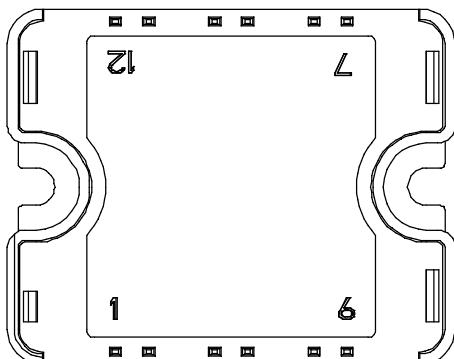
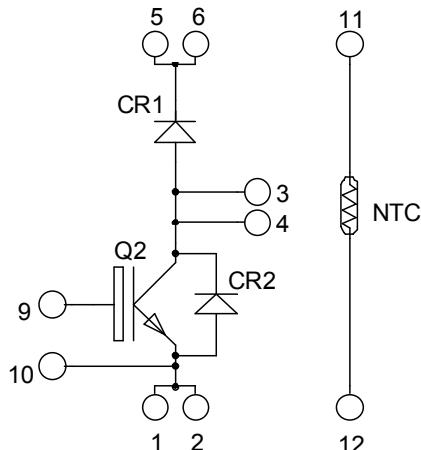


**Boost chopper
NPT IGBT
SiC Chopper diode**

V_{CES} = 600V
I_C = 90A @ T_c = 80°C

Application



Pins 1/2 ; 3/4 ; 5/6 must be shorted together

Absolute maximum ratings

Symbol	Parameter	Max ratings	Unit
V _{CES}	Collector - Emitter Breakdown Voltage	600	V
I _C	Continuous Collector Current	T _c = 25°C	110
		T _c = 80°C	90
I _{CM}	Pulsed Collector Current	T _c = 25°C	315
V _{GE}	Gate – Emitter Voltage	±20	V
P _D	Maximum Power Dissipation	T _c = 25°C	416
RBSOA	Reverse Bias Safe Operating Area	T _j = 150°C	200A @ 600V

 **CAUTION:** These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com

- AC and DC motor control
- Switched Mode Power Supplies
- Power Factor Correction

Features

- **Non Punch Through (NPT) Fast IGBT**
 - Low voltage drop
 - Low tail current
 - Switching frequency up to 100 kHz
 - Low leakage current
 - RBSOA and SCSOA rated
- **Chopper SiC Schottky Diode**
 - Zero reverse recovery
 - Zero forward recovery
 - Temperature Independent switching behavior
 - Positive temperature coefficient on VF
- Very low stray inductance
- Internal thermistor for temperature monitoring
- High level of integration

Benefits

- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Solderable terminals both for power and signal for easy PCB mounting
- Low profile
- RoHS Compliant

All ratings @ $T_j = 25^\circ\text{C}$ unless otherwise specified

Electrical Characteristics

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
I_{CES}	Zero Gate Voltage Collector Current	$V_{GE} = 0\text{V}$, $V_{CE} = 600\text{V}$			250	μA
$V_{CE(\text{sat})}$	Collector Emitter Saturation Voltage	$V_{GE} = 15\text{V}$	$T_j = 25^\circ\text{C}$	2	2.5	V
		$I_C = 100\text{A}$	$T_j = 125^\circ\text{C}$	2.2		
$V_{GE(\text{th})}$	Gate Threshold Voltage	$V_{GE} = V_{CE}$, $I_C = 1.5\text{mA}$	4.5	5.5	6.5	V
I_{GES}	Gate – Emitter Leakage Current	$V_{GE} = 20\text{V}$, $V_{CE} = 0\text{V}$			400	nA

Dynamic Characteristics

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
C_{ies}	Input Capacitance	$V_{GE} = 0\text{V}$; $V_{CE} = 25\text{V}$ $f = 1\text{MHz}$		4.3		nF
C_{res}	Reverse Transfer Capacitance			0.4		
Q_G	Gate charge	$V_{GE} = 15\text{V}$; $V_{CE} = 300\text{V}$ $I_C = 100\text{A}$		240		nC
$T_{d(on)}$	Turn-on Delay Time	Inductive Switching (25°C) $V_{GE} = \pm 15\text{V}$ $V_{Bus} = 300\text{V}$ $I_C = 100\text{A}$ $R_G = 2.2\Omega$		25		ns
T_r	Rise Time			10		
$T_{d(off)}$	Turn-off Delay Time			130		
T_f	Fall Time			20		
$T_{d(on)}$	Turn-on Delay Time	Inductive Switching (125°C) $V_{GE} = \pm 15\text{V}$ $V_{Bus} = 300\text{V}$ $I_C = 100\text{A}$ $R_G = 2.2\Omega$		25		ns
T_r	Rise Time			11		
$T_{d(off)}$	Turn-off Delay Time			150		
T_f	Fall Time			30		
E_{on}	Turn-on Switching Energy	$V_{GE} = \pm 15\text{V}$ $V_{Bus} = 300\text{V}$ $I_C = 100\text{A}$ $R_G = 2.2\Omega$	$T_j = 125^\circ\text{C}$		0.6	mJ
E_{off}	Turn-off Switching Energy		$T_j = 125^\circ\text{C}$		3	
I_{sc}	Short Circuit data	$V_{GE} \leq 15\text{V}$; $V_{Bus} = 360\text{V}$ $t_p \leq 10\mu\text{s}$; $T_j = 125^\circ\text{C}$		450		A

Chopper SiC diode ratings and characteristics

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
V_{RRM}	Maximum Peak Repetitive Reverse Voltage		600			V
I_{RM}	Maximum Reverse Leakage Current	$V_R = 600\text{V}$	$T_j = 25^\circ\text{C}$	200	800	μA
			$T_j = 175^\circ\text{C}$	400	4000	
I_F	DC Forward Current		$T_c = 100^\circ\text{C}$	40		A
V_F	Diode Forward Voltage	$I_F = 40\text{A}$	$T_j = 25^\circ\text{C}$	1.6	1.8	V
			$T_j = 175^\circ\text{C}$	2	2.4	
Q_C	Total Capacitive Charge	$I_F = 40\text{A}$, $V_R = 300\text{V}$ $di/dt = 1200\text{A}/\mu\text{s}$		56		nC
C	Total Capacitance	$f = 1\text{MHz}$, $V_R = 200\text{V}$		260		pF
		$f = 1\text{MHz}$, $V_R = 400\text{V}$		200		

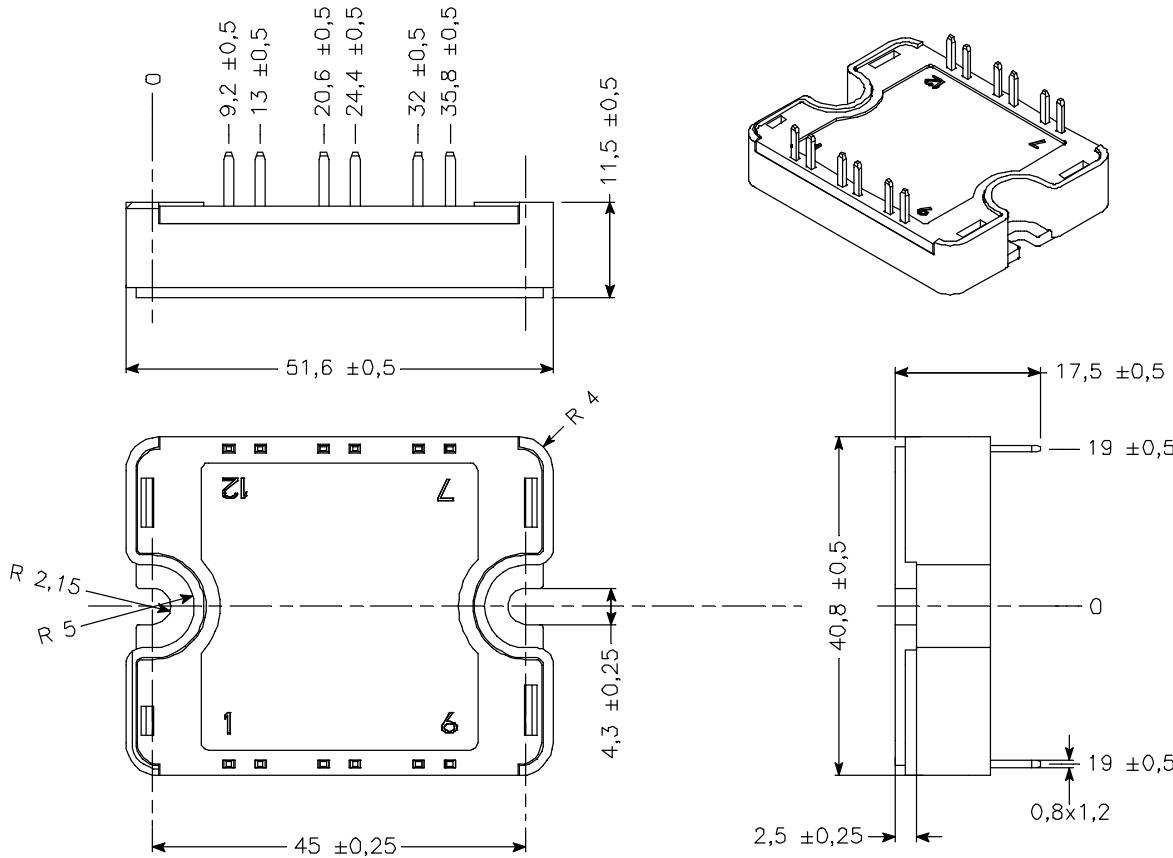
Thermal and package characteristics

Symbol	Characteristic		Min	Typ	Max	Unit
R_{thJC}	Junction to Case Thermal Resistance	IGBT			0.3	°C/W
		SiC chopper diode			0.8	
V_{ISOL}	RMS Isolation Voltage, any terminal to case t = 1 min, $I_{isol} < 1mA$, 50/60Hz	4000				V
T_J	Operating junction temperature range	-40		150		
T_{STG}	Storage Temperature Range	-40		125		°C
T_C	Operating Case Temperature	-40		100		
Torque	Mounting torque	To heatsink	M4	2.5	4.7	N.m
Wt	Package Weight				80	g

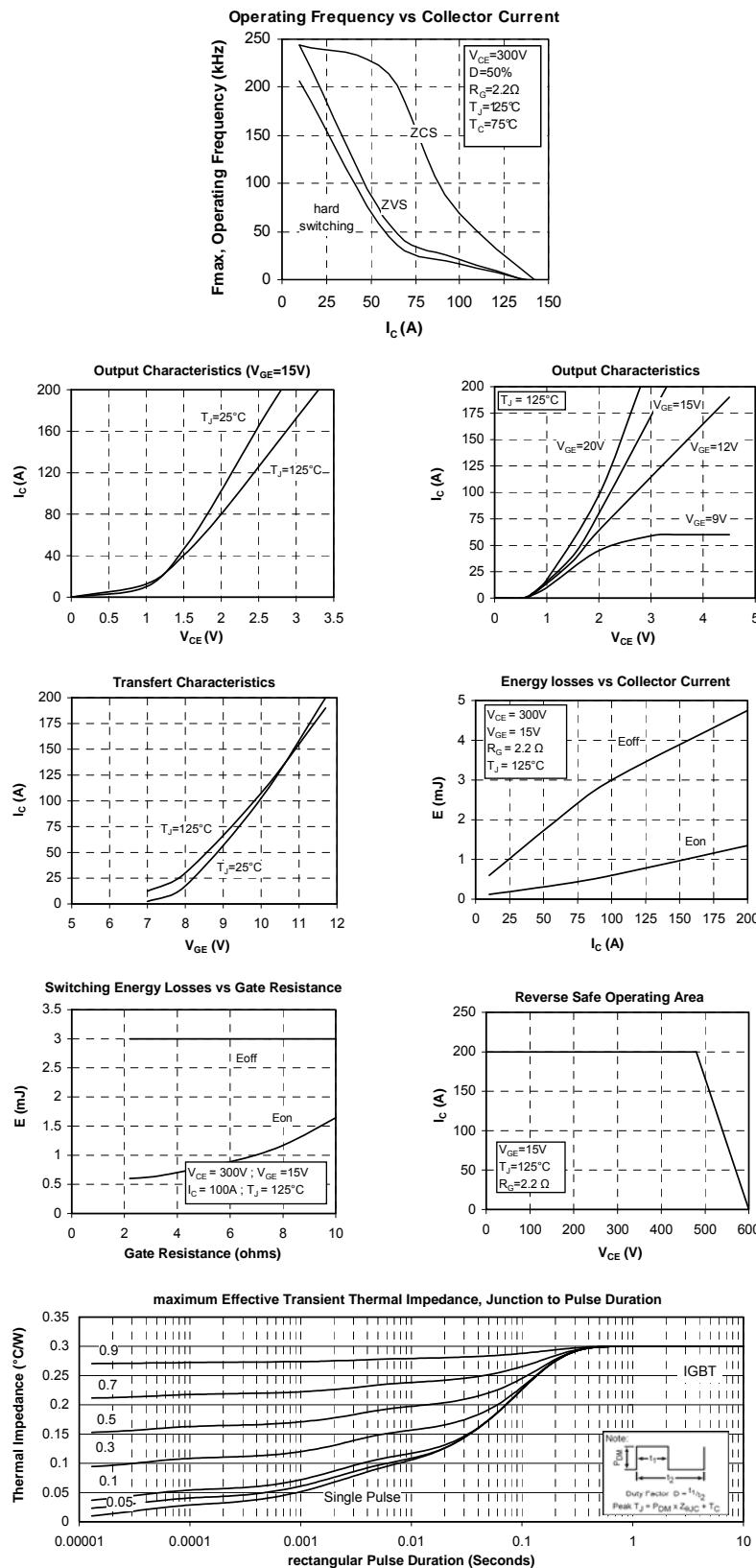
Temperature sensor NTC (see application note APT0406 on www.microsemi.com for more information).

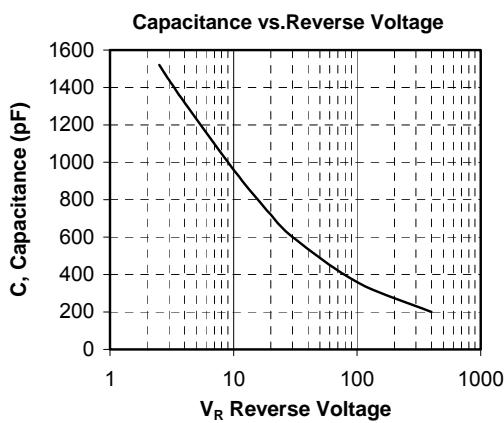
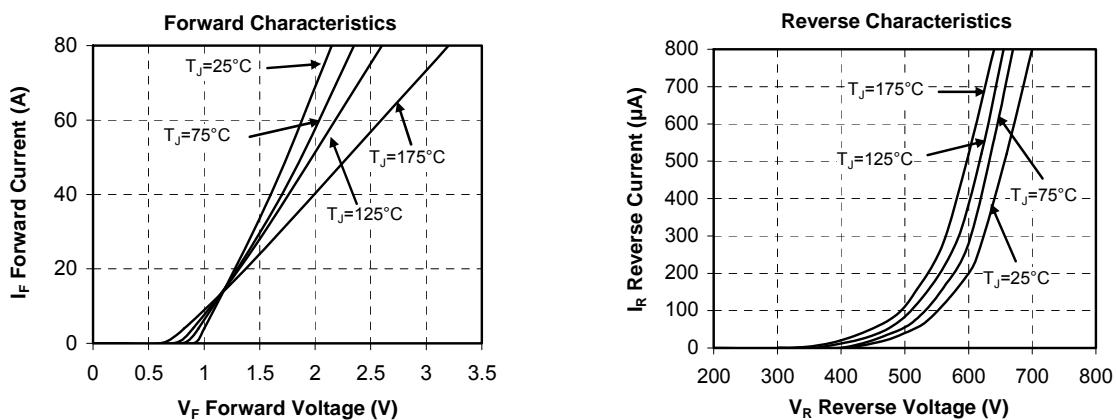
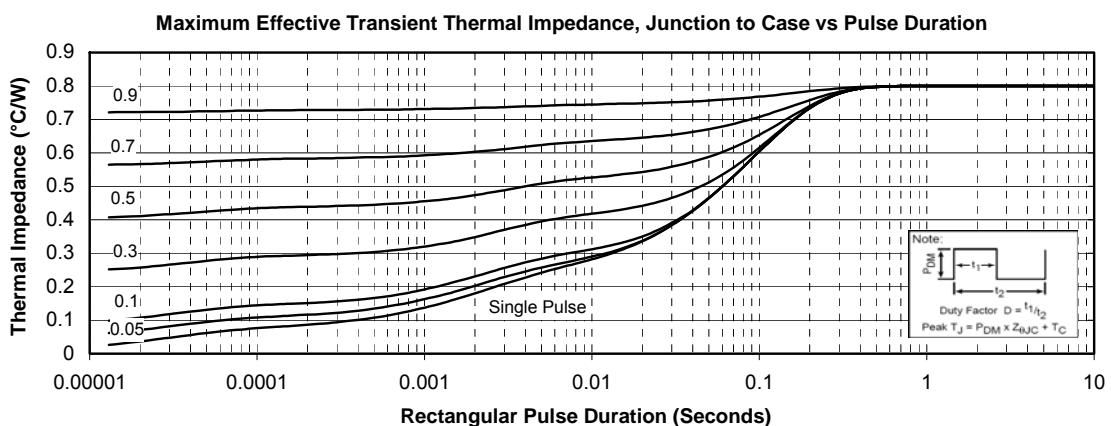
Symbol	Characteristic		Min	Typ	Max	Unit
R_{25}	Resistance @ 25°C			50		kΩ
$\Delta R_{25}/R_{25}$				5		%
$B_{25/85}$	$T_{25} = 298.15 \text{ K}$			3952		K
$\Delta B/B$		$T_C=100^\circ\text{C}$		4		%

$$R_T = \frac{R_{25}}{\exp\left[B_{25/85}\left(\frac{1}{T_{25}} - \frac{1}{T}\right)\right]} \quad \begin{array}{l} T: \text{ Thermistor temperature} \\ R_T: \text{ Thermistor value at } T \end{array}$$

SP1 Package outline (dimensions in mm)

See application note 1904 - Mounting Instructions for SP1 Power Modules on www.microsemi.com

Typical IGBT Performance Curve



Typical SiC chopper diode Performance Curve


Microsemi reserves the right to change, without notice, the specifications and information contained herein

Microsemi's products are covered by one or more of U.S patents 4,895,810 5,045,903 5,089,434 5,182,234 5,019,522 5,262,336 6,503,786 5,256,583 4,748,103 5,283,202 5,231,474 5,434,095 5,528,058 6,939,743 7,352,045 5,283,201 5,801,417 5,648,283 7,196,634 6,664,594 7,157,886 6,939,743 7,342,262 and foreign patents. U.S and Foreign patents pending. All Rights Reserved.